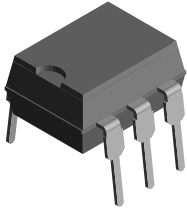
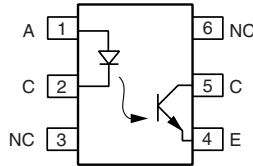


Optocoupler, Phototransistor Output, no Base Connection



18216



DESCRIPTION

The CNY17F is an optocoupler consisting of a gallium arsenide infrared emitting diode optically coupled to a silicon planar phototransistor detector in a plastic plug-in DIP-6 package.

The coupling device is suitable for signal transmission between two electrically separated circuits. The potential difference between the circuits to be coupled is not allowed to exceed the maximum permissible reference voltages.

In contrast to the CNY17 series, the base terminal of the F type is not connected, resulting in a substantially improved common-mode interference immunity.

FEATURES

- Isolation test voltage, 5300 V_{RMS}
- No base terminal connection for improved common mode interface immunity
- Long term stability
- Industry standard dual-in-line package
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC


RoHS
COMPLIANT

AGENCY APPROVALS

- UL1577, file no. E52744 system code H or J, double protection
- DIN EN 60747-5-5 (VDE 0884) available with option 1
- BSI IEC 60950; IEC 60065
- FIMKO

ORDER INFORMATION

PART	REMARKS
CNY17F-1	CTR 40 % to 80 %, DIP-6
CNY17F-2	CTR 63 % to 125 %, DIP-6
CNY17F-3	CTR 100 % to 200 %, DIP-6
CNY17F-4	CTR 160 % to 320 %, DIP-6
CNY17F-1X006	CTR 40 % to 80 %, DIP-6 400 mil (option 6)
CNY17F-1X007	CTR 40 % to 80 %, SMD-6 (option 7)
CNY17F-1X009	CTR 40 % to 80 %, SMD-6 (option 9)
CNY17F-2X006	CTR 63 % to 125 %, DIP-6 400 mil (option 6)
CNY17F-2X007	CTR 63 % to 125 %, SMD-6 (option 7)
CNY17F-2X009	CTR 63 % to 125 %, SMD-6 (option 9)
CNY17F-3X006	CTR 100 % to 200 %, DIP-6 400 mil (option 6)
CNY17F-3X007	CTR 100 % to 200 %, SMD-6 (option 7)
CNY17F-3X009	CTR 100 % to 200 %, SMD-6 (option 9)
CNY17F-4X006	CTR 160 % to 320 %, DIP-6 400 mil (option 6)
CNY17F-4X007	CTR 160 % to 320 %, SMD-6 (option 7)
CNY17F-4X009	CTR 160 % to 320 %, SMD-6 (option 9)

Note

For additional information on the available options refer to option information.

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
INPUT				
Reverse voltage		V_R	6	V
DC forward current		I_F	60	mA
Surge forward current	$t \leq 10 \mu\text{s}$	I_{FSM}	2.5	A
Power dissipation		P_{diss}	100	mW
OUTPUT				
Collector emitter breakdown voltage		BV_{CEO}	70	V
Collector current		I_C	50	mA
	$t \leq 1 \text{ ms}$	I_C	100	mA
Total power dissipation		P_{diss}	150	mW
COUPLER				
Isolation test voltage between emitter and detector		V_{ISO}	5300	V_{RMS}
Creepage distance			≥ 7	mm
Clearance distance			≥ 7	mm
Isolation thickness between emitter and detector			≥ 0.4	mm
Comparative tracking index per DIN IEC 112/VDE 0303, part 1			175	
Isolation resistance	$V_{IO} = 500 \text{ V}$	R_{IO}	$\geq 10^{11}$	Ω
Storage temperature range		T_{stg}	- 55 to + 150	$^{\circ}\text{C}$
Ambient temperature range		T_{amb}	- 55 to + 100	$^{\circ}\text{C}$
Junction temperature		T_j	100	$^{\circ}\text{C}$
Soldering temperature	max. 10 s, dip soldering: distance to seating plane $\geq 1.5 \text{ mm}$	T_{sld}	260	$^{\circ}\text{C}$

Note

$T_{amb} = 25 \text{ }^{\circ}\text{C}$, unless otherwise specified.

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

ELECTRICAL CHARACTERISTICS							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT							
Forward voltage	$I_F = 60 \text{ mA}$		V_F		1.25	1.65	V
Breakdown voltage	$I_R = 10 \mu\text{A}$		V_{BR}	6			V
Reverse current	$V_R = 6 \text{ V}$		I_R		0.01	10	μA
Capacitance	$V_R = 0 \text{ V}, f = 1 \text{ MHz}$		C_O		25		pF
Thermal resistance			R_{th}		750		K/W
OUTPUT							
Collector emitter capacitance	$V_{CE} = 5 \text{ V}, f = 1 \text{ MHz}$		C_{CE}		5.2		pF
Base collector capacitance	$V_{CE} = 5 \text{ V}, f = 1 \text{ MHz}$		C_{BC}		6.5		pF
Emitter base capacitance	$V_{CE} = 5 \text{ V}, f = 1 \text{ MHz}$		C_{EB}		7.5		pF
Thermal resistance			R_{th}		500		K/W
COUPLER							
Collector emitter, saturation voltage	$I_F = 10 \text{ mA}, I_C = 2.5 \text{ mA}$		V_{CEsat}		0.25	0.4	V
Coupling capacitance			C_C		0.6		pF
Collector emitter, leakage current	$V_{CE} = 10 \text{ V}$	CNY17F-1	I_{CEO}		2	50	nA
		CNY17F-2	I_{CEO}		2	50	nA
		CNY17F-3	I_{CEO}		5	100	nA
		CNY17F-4	I_{CEO}		5	100	nA

Note

$T_{amb} = 25 \text{ }^{\circ}\text{C}$, unless otherwise specified.

Minimum and maximum values were tested requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.



CURRENT TRANSFER RATIO							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Current transfer ratio	$I_F = 10 \text{ mA}$	CNY17F-1	CTR	40		80	%
		CNY17F-2	CTR	63		125	%
		CNY17F-3	CTR	100		200	%
		CNY17F-4	CTR	160		320	%
	$I_F = 1.0 \text{ mA}$	CNY17F-1	CTR	13	30		%
		CNY17F-2	CTR	22	45		%
		CNY17F-3	CTR	34	70		%
		CNY17F-4	CTR	56	90		%

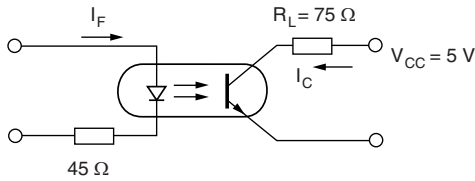
Note

Current transfer ratio I_C/I_F at $V_{CE} = 5.0 \text{ V}$, 25°C and collector emitter leakage current by dash number.

SWITCHING CHARACTERISTICS							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
LINEAR OPERATION (without saturation)							
Turn-on time	$I_F = 10 \text{ mA}$, $V_{CC} = 5 \text{ V}$, $R_L = 75 \Omega$		t_{on}		3		μs
Rise time	$I_F = 10 \text{ mA}$, $V_{CC} = 5 \text{ V}$, $R_L = 75 \Omega$		t_r		2		μs
Turn-off time	$I_F = 10 \text{ mA}$, $V_{CC} = 5 \text{ V}$, $R_L = 75 \Omega$		t_{off}		2.3		μs
Fall time	$I_F = 10 \text{ mA}$, $V_{CC} = 5 \text{ V}$, $R_L = 75 \Omega$		t_f		2		μs
Cut-off frequency	$I_F = 10 \text{ mA}$, $V_{CC} = 5 \text{ V}$, $R_L = 75 \Omega$		f_{CO}		250		kHz
SWITCHING OPERATION (with saturation)							
Turn-on time	$I_F = 20 \text{ mA}$	CNY17F-1	t_{on}		3		μs
	$I_F = 10 \text{ mA}$	CNY17F-2	t_{on}		4.2		μs
		CNY17F-3	t_{on}		4.2		μs
		CNY17F-4	t_{on}		6		μs
Rise time	$I_F = 20 \text{ mA}$	CNY17F-1	t_r		2		μs
	$I_F = 10 \text{ mA}$	CNY17F-2	t_r		3		μs
		CNY17F-3	t_r		3		μs
	$I_F = 5 \text{ mA}$	CNY17F-4	t_r		4.6		μs
Turn-off time	$I_F = 20 \text{ mA}$	CNY17F-1	t_{off}		18		μs
	$I_F = 10 \text{ mA}$	CNY17F-2	t_{off}		23		μs
		CNY17F-3	t_{off}		23		μs
		CNY17F-4	t_{off}		25		μs
Fall time	$I_F = 20 \text{ mA}$	CNY17F-1	t_f		11		μs
	$I_F = 10 \text{ mA}$	CNY17F-2	t_f		14		μs
		CNY17F-3	t_f		14		μs
		CNY17F-4	t_f		15		μs

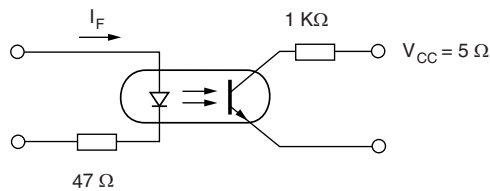
TYPICAL CHARACTERISTICS

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified



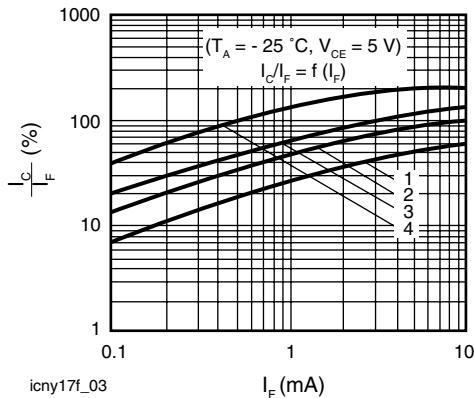
icny17f_01

Fig. 1 - Linear Operation (without Saturation)



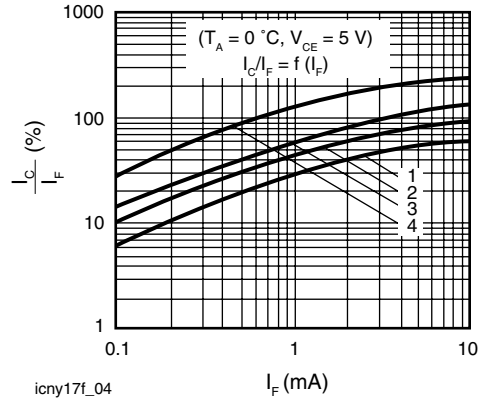
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Fig. 2 - Switching Operation (with Saturation)



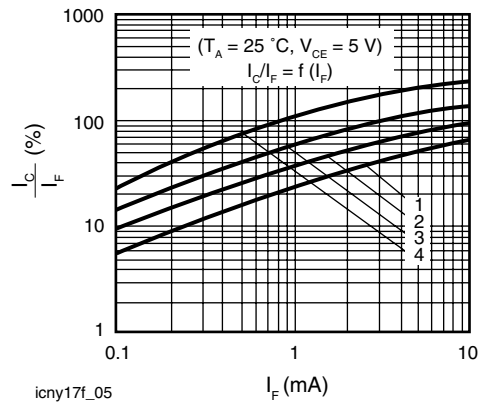
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Fig. 3 - Current Transfer Ratio vs. Diode Current



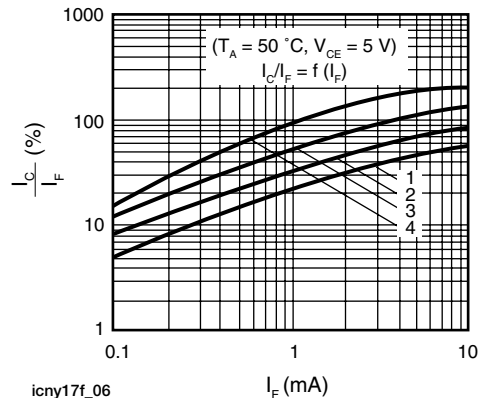
icny17f_04

Fig. 4 - Current Transfer Ratio vs. Diode Current



icny17f_05

Fig. 5 - Current Transfer Ratio vs. Diode Current



icny17f_06

Fig. 6 - Current Transfer Ratio vs. Diode Current

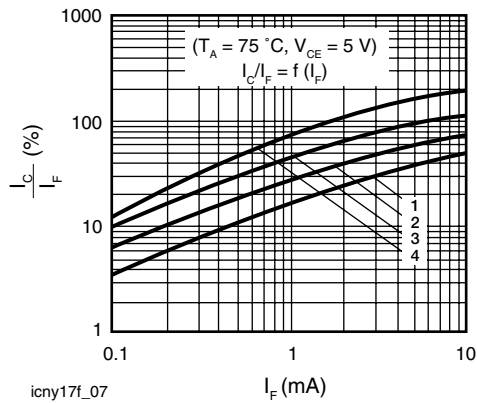


Fig. 7 - Current Transfer Ratio vs. Diode Current

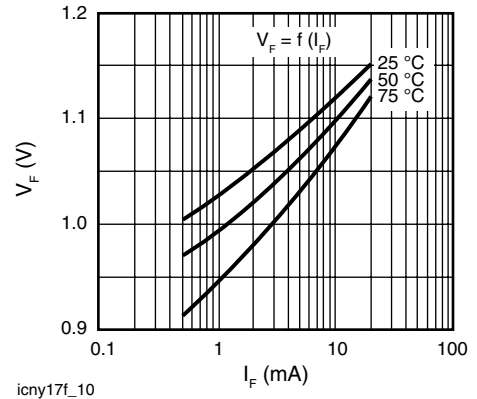


Fig. 10 - Forward Voltage

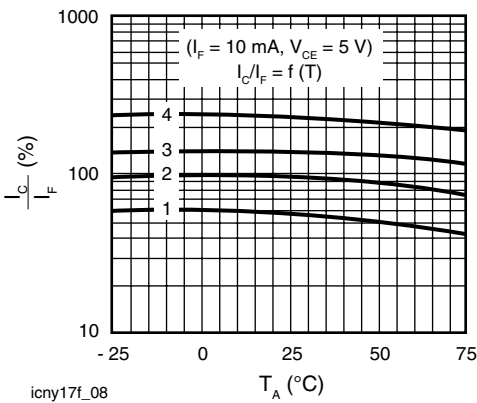


Fig. 8 - Current Transfer Ratio (CTR) vs. Temperature

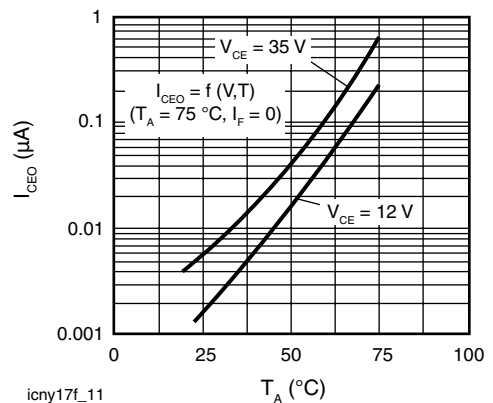


Fig. 11 - Collector Emitter Off-state Current

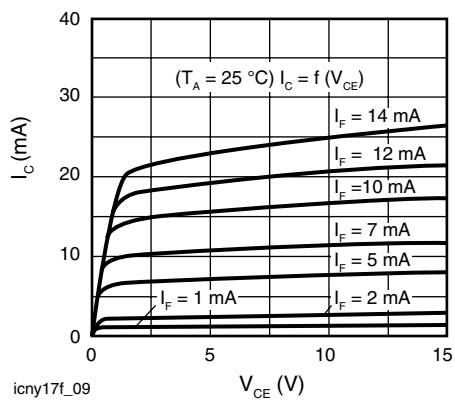


Fig. 9 - Output Characteristics CNY17F-2, -3

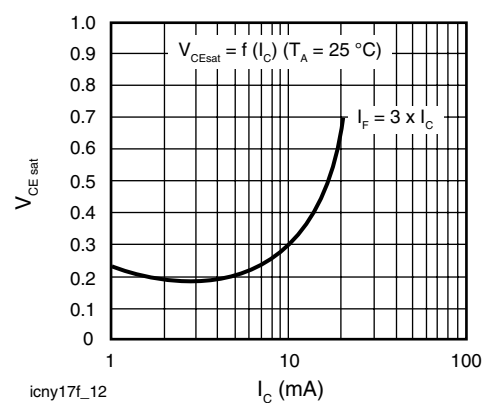


Fig. 12 - Saturation Voltage vs. Collector Current and Modulation Depth CNY17F-1

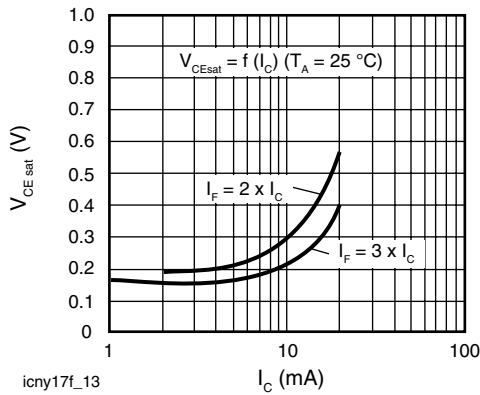


Fig. 13 - Saturation Voltage vs. Collector Current and Modulation Depth CNY17F-2

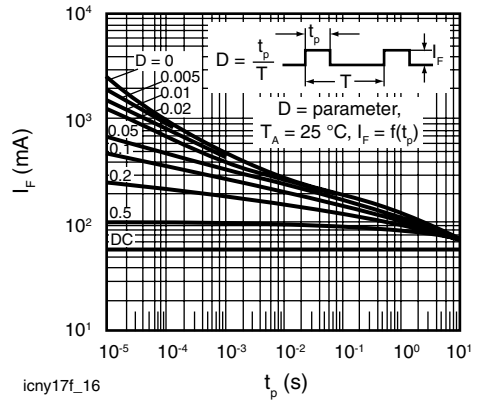


Fig. 16 - Permissible Pulse Load

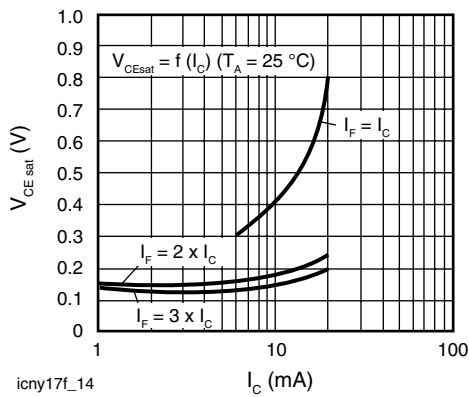


Fig. 14 - Saturation Voltage vs. Collector Current and Modulation Depth CNY17F-3

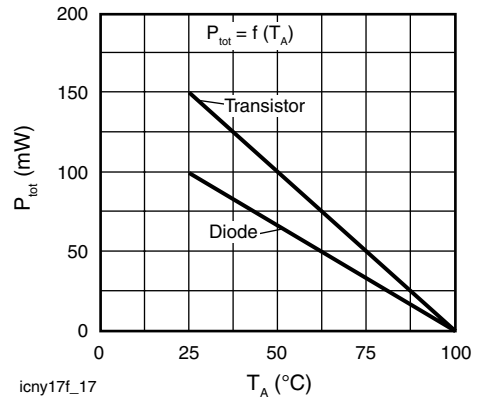


Fig. 17 - Permissible Power Dissipation for Transistor and Diode

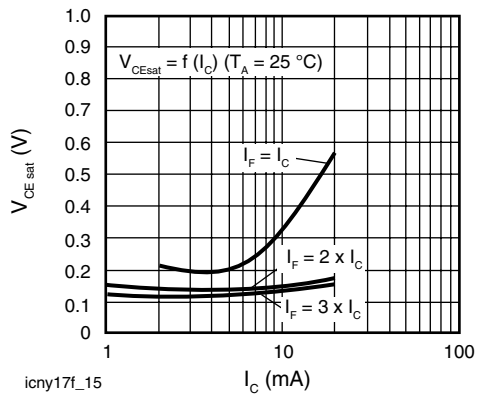


Fig. 15 - Saturation Voltage vs. Collector Current and Modulation Depth CNY17F-4

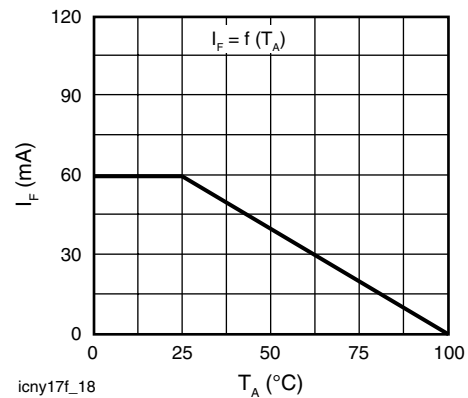
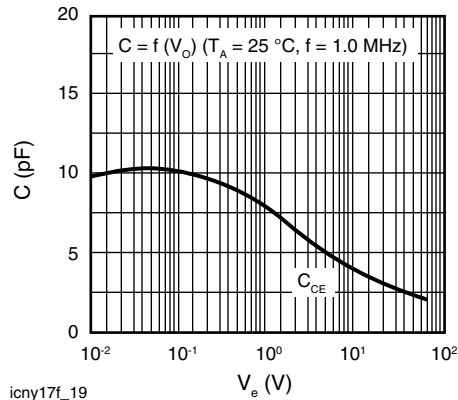
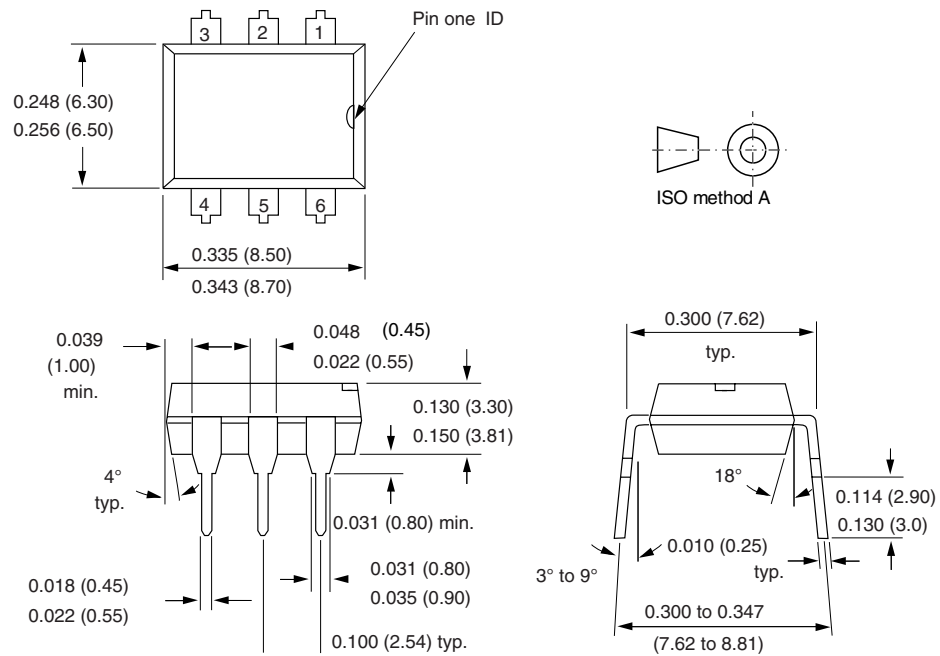


Fig. 18 - Permissible Forward Current Diode



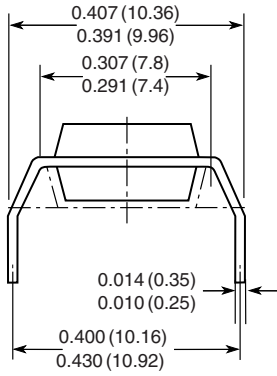
icny17f_19

Fig. 19 - Transistor Capacitance

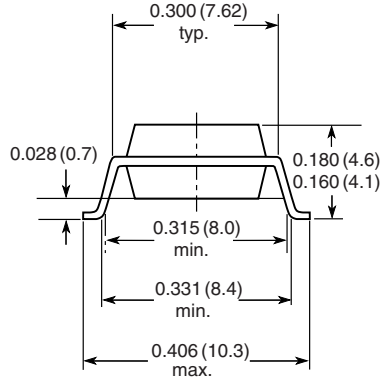
PACKAGE DIMENSIONS in inches (millimeters)


i178004

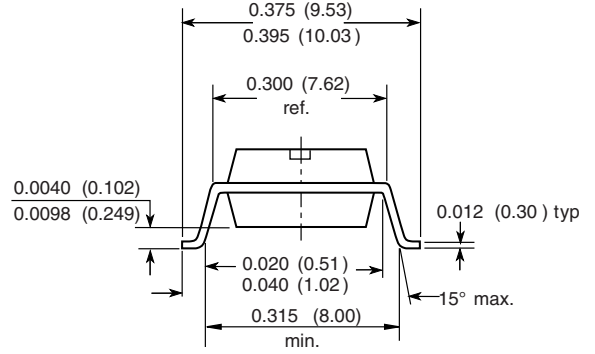
Option 6



Option 7



Option 9



18450

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It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively.
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design
and may do so without further notice.

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Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany



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